SEP 2 1 2000	
IN THE UNITED STATES PAT	Atty Docket No: SEL 175 ENT AND TRADEMARK OFFICE I hereby certify that this correspondence
In re application of: Kawasaki et al. Serial No: 09/550,829 Filed: April 18, 2000 For: Semiconductor Device And The Fabricating Method There Art Unit: Examiner:) is being deposited with the United States) Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents Washington
Assistant Commissioner for Patents P/ 09 - 2	28-2000 <u>Castae September 18, 2</u> 00
Washington, D. C. 20231 Sir: 9 / 18 / 2000	
Please record the attached original do 101	474090 . pages (with cover sheet): 2
1. Name of Conveying Party(ies): <u>Ritsuko KAWASAKI, Hiroki ADACHI, Kazuhide</u> <u>TOMIYASU and Hiroyuki OGAWA</u>	5. Name and Address of Party to Whom Correspondence Concerning Document Should be Mailed:
2a. Name and Address of Receiving Party(ies): Name: Semiconductor Energy Laboratory Co., Ltd. Address: 398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan	Edward D. Manzo, Esq. COOK, ALEX, McFARRON, MANZO, CUMMINGS & MEHLER, LTD. 200 West Adams Street, Suite 2850 Chicago, Illinois 60606
2b. Name and Address of Receiving Party(ies): Name: Sharp Kabushiki Kaisha Address 22-22, Nagaike-cho, Abeno-ku, Osaka-shi, Osaka 545-0013 Japan	 6. Total Number of Applications and Patents Involved: 1 7. Total Fee (37 CFR 3.41): \$40.00 7a. X Enclosed
3. Nature of Conveyance X Assignment	7b. X Authorized to be Charged to Deposit Account For Any Deficiency
MergerSecurity AgreementChange of Name	8. Deposit Account Number: 50/1039 (A duplicate copy of this page is attached)
Other X Execution Date: 8/23/00; 8/29/00; 8/31/00; 9/11/00	9. Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a
4. Application Number(s) or Patent number(s) (If this document is being filed together with a new application, the execution date of the application is:)	true copy of the original document.
4a. Patent Application No.(s) <u>09/550,829</u>	Mark J. Murphy Name of Person Signing Signature Reg. No. 34,225
4b. Patent No.(s)	Date: September 18, 2000
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PATENT REEL: 011109 FRAME: 0229

ASSIGNMENT

Identity Of The Patent Application. I am the inventor (or one joint inventor) of a patent application that I am assigning. The patent application I am assigning is entitled <u>SEMICONDUCTOR DEVICE AND THE FABRICATING METHOD THEREFOR</u> which I executed herewith. If the patent application has already been filed, it received serial number <u>09/550,829</u> and bears a filing date of April 18, 2000.

The Assignee and The Assignment. I assign my patent rights to Semiconductor Energy Laboratory Co., Ltd. a corporation organized according to the laws of Japan, having a place of business at 398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan and Sharp Kabushiki Kaisha. a corporation organized according to the laws of Japan, having a place of business at 22-22, Nagaike-cho, Abeno-ku, Osaka-shi, Osaka 545-0013 Japan (hereinafter "the Assignee"). The rights I assign are my entire right, title and interest in the invention or improvements disclosed in the patent application and any and all other applications for United States Letters Patent which I may file, either solely or jointly with others, on the invention or improvements, including all continuations, divisionals, and continuations-in-part, and in any and all United States Letters Patent which may be obtained on any of said applications, and in any reissue or extension thereof. I also assign to the Assignee all priority rights under the International Convention. I agree to execute, at the request of the Assignee, all documents in connection with any application for United States letters patent therefor.

Payment Received. I am making this assignment in consideration of One Dollar and other good and valuable consideration. I acknowledge the receipt and sufficiency of the consideration.

Authorizations. I request the U.S. Commissioner of Patents and Trademarks to issue the Letters Patent to the Assignee. I authorize the attorney(s) of record in the application to insert in this assignment document the date and serial number of the application.

Further Acts. I agree, upon the request and at the expense of the Assignee, to execute any divisional, continuation or substitute application for the invention or improvements, and any oath, declaration or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon the application. I agree to perform, upon request, any affirmative acts to obtain said Letters Patent of the United States and to vest in the Assignee all rights therein, so that the Letters Patent will be held and enjoyed by the Assignee, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me if this assignment had not been made.

Interference. In the event that any application or Letters Patent that I now assign becomes involved in interference, I agree to cooperate to the best of my ability in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof.

Ritsuko Kawasaki c9/11/2000 Name: Ritsuko KAWASAKI Date

Name: Hiroki ADACHI 08/23/5000
Date

Name: Kazuhide TOMIYASU Date

Hiroyuki OGAWA Date

PATENT RECORDED: 09/21/2000 REEL: 011109 FRAME: 0230